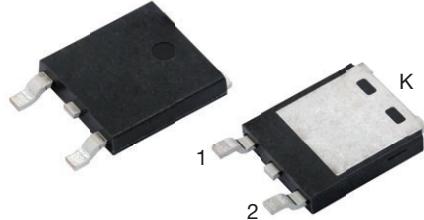
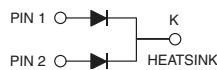


Surface-Mount ESD Capability Rectifier

eSMP® Series


SlimDPAK (TO-252AE)


LINKS TO ADDITIONAL RESOURCES


AUTOMOTIVE GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Very low profile - typical height of 1.3 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both industry and automotive applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102, M3 and HM3 suffix meets JESD 201 class 2 whisker test

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 x 3 A
V_{RRM}	100 V, 200 V, 400 V, 600 V
I_{FSM}	42 A
V_F at $I_F = 3$ A ($T_A = 125$ °C)	0.94 V
T_J max.	175 °C
Package	SlimDPAK (TO-252AE)
Circuit configuration	Common cathode

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)						
PARAMETER	SYMBOL	SE60PWBC	SE60PWDC	SE60PWGC	SE60PWJC	UNIT
Device marking code		SE60PWBC	SE60PWDC	SE60PWGC	SE60PWJC	
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V
Maximum average forward rectified current per device (fig. 1)	$I_{F(AV)}^{(1)}$	6				A
per diode		3				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	42				A
Peak forward surge current 1 ms square wave on rated load		80				A
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +175				°C

Note

⁽¹⁾ With infinite heatsink

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum Instantaneous forward voltage	$I_F = 1.5 \text{ A}$	$T_A = 25^\circ\text{C}$	V_F ⁽¹⁾	0.94	-	V
	$I_F = 3.0 \text{ A}$			1.03	1.1	
	$I_F = 1.5 \text{ A}$			0.84	-	
	$I_F = 3.0 \text{ A}$			0.94	1.01	
Reverse current	Rated V_R	$T_A = 25^\circ\text{C}$	I_R ⁽²⁾	-	10	μA
		$T_A = 125^\circ\text{C}$		12	150	
Typical reverse recovery time	$I_F = 0.5 \text{ A}$, $I_R = 1.0 \text{ A}$, $I_{rr} = 0.25 \text{ A}$	t_{rr}		1200	-	ns
Typical junction capacitance	4.0 V, 1 MHz	C_J		22	-	pF

Notes

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: pulse width $\leq 40 \text{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	SE60PWBC	SE60PWDC	SE60PWGC	SE60PWJC	UNIT
Typical thermal resistance per device	$R_{\theta JA}$ ⁽¹⁾⁽²⁾	63				$^\circ\text{C/W}$
	$R_{\theta JM}$ ⁽³⁾	2.3				

Notes

(1) The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient

(3) Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ - junction-to-mount

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS

($T_A = 25^\circ\text{C}$ unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE
AEC-Q101-001	Human body model (contact mode)	$C = 100 \text{ pF}$, $R = 1.5 \text{ k}\Omega$	V_C	H3B	> 8 kV

ORDERING INFORMATION (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
SE60PWJC-M3/I	0.20	I	4500	13" diameter plastic tape and reel
SE60PWJCHM3/I ⁽¹⁾	0.20	I	4500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

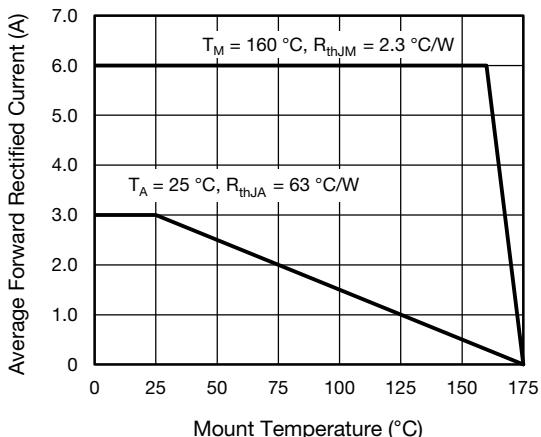


Fig. 1 - Maximum Forward Current Derating Curve

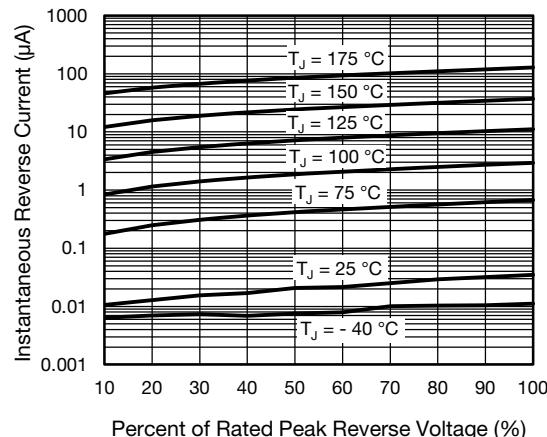


Fig. 4 - Typical Reverse Leakage Characteristics

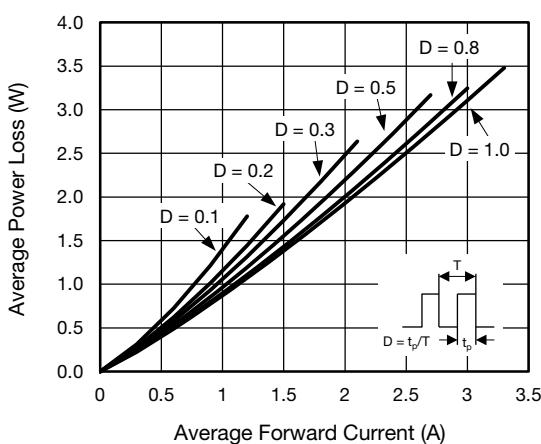


Fig. 2 - Forward Power Loss Characteristics

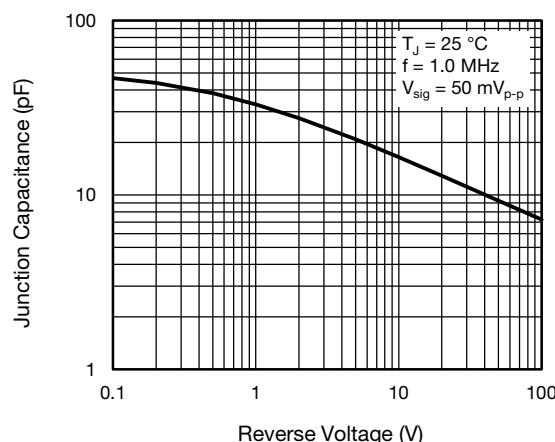


Fig. 5 - Typical Junction Capacitance

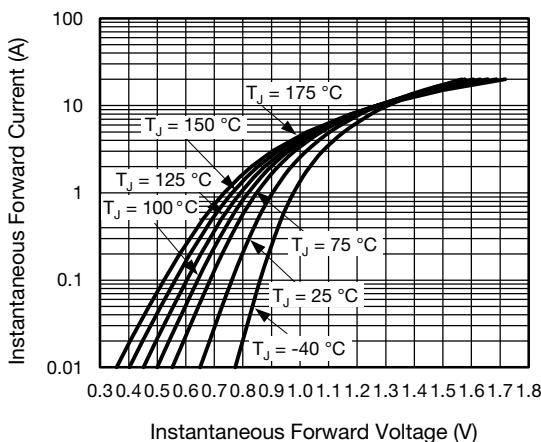


Fig. 3 - Typical Instantaneous Forward Characteristics

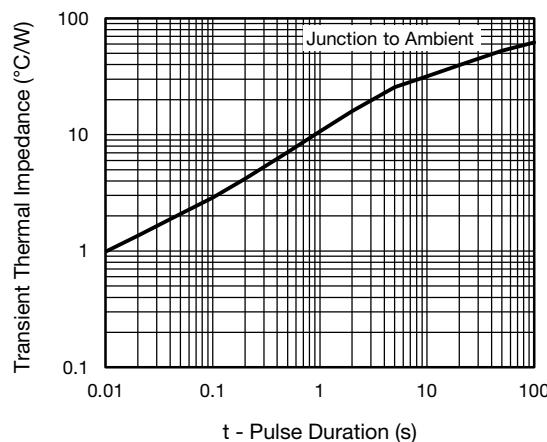
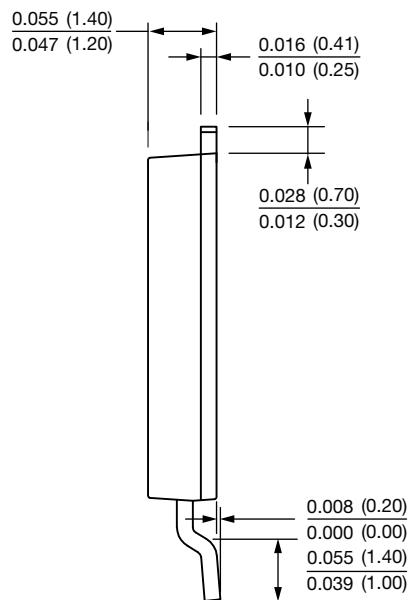
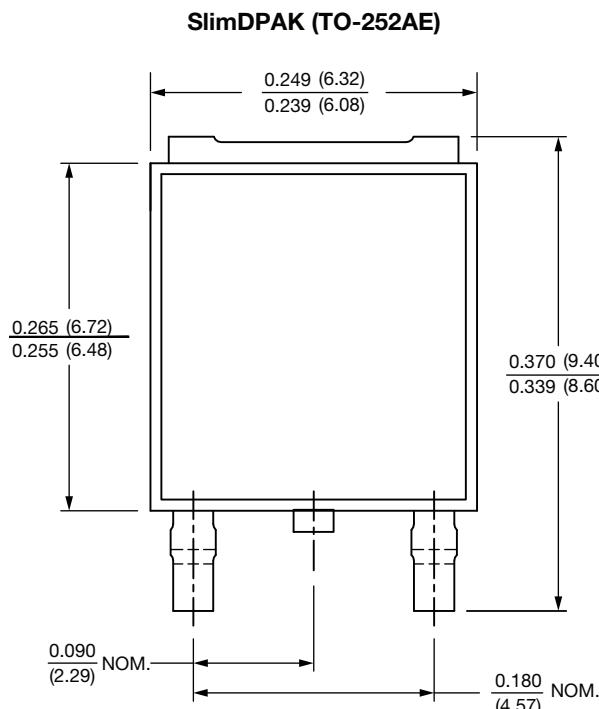
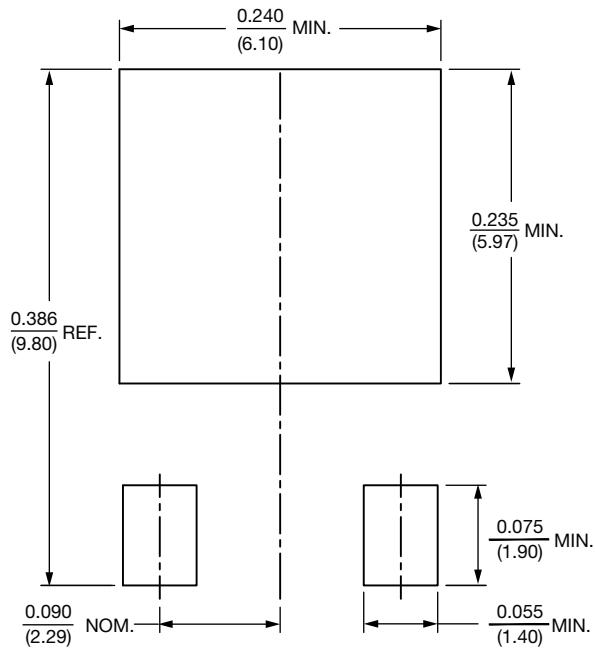
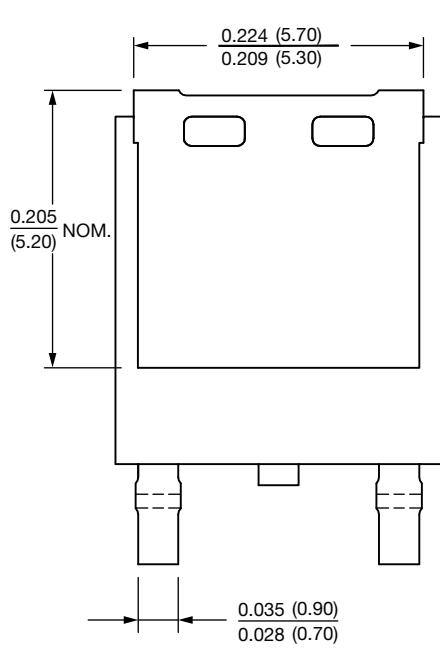


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



Mounting Pad Layout



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